

11-MD123

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*Low-saturation, Low-voltage
Bi-directional Motor Driver*



SILICON TOUCH TECHNOLOGY INC.
新竹市科學園區展業一路九號四樓之三
9-4F-3 Prosperity Road I Science-Based Industrial Park
Hsinchu, Taiwan 300, R.O.C.
Tel : 886-3-5645656 Fax : 886-3-5645626

11-MD123

Low-saturation, Low-voltage Bi-directional Motor Driver

General Specifications

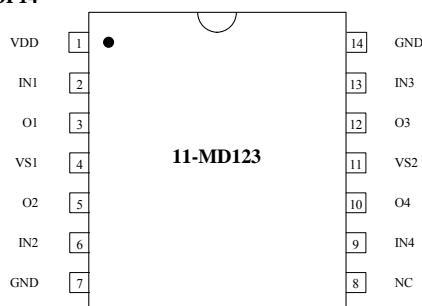
The device is a two-channel low-saturation bi-directional motor driver IC. The design is optimal for stepper-motor applications, such as cameras, printers, FDDs, or other portable devices.

Features and Benefits

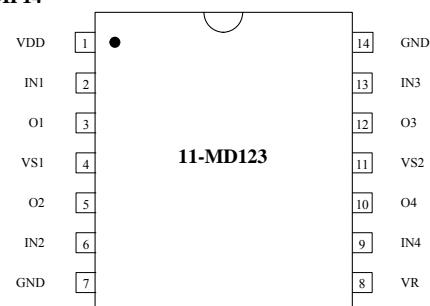
- Low voltage operation ($V_{DD\ min} = V_{S1\ min} = V_{S2\ min} = 1.5V$)
- Low saturation voltage (Upper transistor + low transistor residual voltage; 0.5V typ. at 400mA)
- Parallel connection (two-channel driver: Upper transistor + low transistor residual; 0.6V typ. at 800mA)
- Separate control logic power supply and motor driver power supply
- Brake function
- High output sinking and driving capability
- SOP14 / DIP-14 package

Pin Assignment

SOP14



DIP14





PIN NO.	PIN NAME	DESCRIPTION
1	VDD	Power supply pin for controller.
2	IN1	Input pin that determines driving mode.
3	O1	Output sinking / driving pin.
4	VS1	Power supply pin for output driver O1/ O2.
5	O2	Output sinking / driving pin.
6	IN2	Input pin that determines driving mode.
7	GND	Ground pin
8	NC / VR	No connection (SOP14) / Voltage Reference Output (DIP14)
9	IN4	Input pin that determines driving mode.
10	O4	Output sinking / driving pin.
11	VS2	Power supply pin for output driver O3/ O4.
12	O3	Output sinking / driving pin.
13	IN3	Input pin that determines driving mode.
14	GND	Ground pin

Absolute Maximum Ratings (Unless otherwise noted, $T_A=25^\circ C$)

Characteristic	Symbol	Rating	Unit
Supply Voltage	V_{DD}	6.0	V
	V_S	6.0	V
Input Voltage	V_{IN}	$V_{DD}+0.4$	V
I_o Peak Current (in parallel connection)	I_{OPeak}	2.5	A
I_{ODC} Current (in parallel connection)	I_{ODC}	1	A
Power Dissipation (SOP14)	$P_{D-SOP14}$	800	mW
Power Dissipation (DIP14)	$P_{D-DIP14}$	1130	mW
Operating Temperature Range	T_{OPR}	-40 ~ 125	$^\circ C$
Storage Temperature Range	T_{STG}	-65 ~ 150	$^\circ C$



Electrical Characteristic

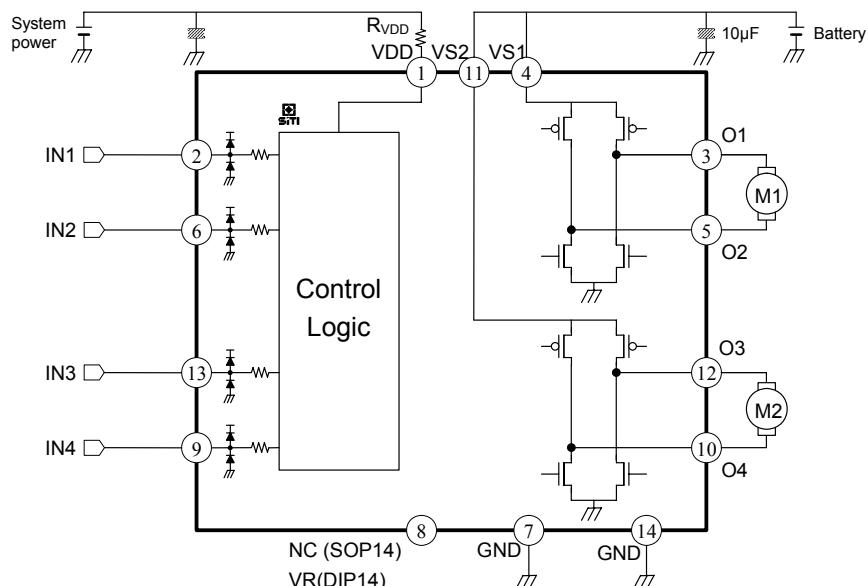
(Unless otherwise noted, $T_A = 25^\circ C$ & $V_{DD} = V_S = 3V$)

Characteristic	Sym.	Condition	Limit			Unit
			Min.	Typ.	Max.	
Supply Voltage	V_{DD}		1.5	3	5.5	V
	V_S		1.5	3	5.5	V
Supply Current ($I_{DD} + I_S$)	I_{DD0}	$V_{IN1}, V_{IN2}, V_{IN3}, V_{IN4} = 0V$		0.1	10	μA
	I_{DD1}	$V_{IN1}=3V, V_{IN2}, V_{IN3}, V_{IN4}=0V$		0.05	0.5	mA
	I_{DD2}	$V_{IN1}, V_{IN2}=3V, V_{IN3}, V_{IN4}=0V$		0.05	0.5	mA
VR Terminal (DIP14) ($T_J = 25^\circ C$)						
Output Voltage	V_{VR}	$V_{DD}=3V$, No loading	1.05	1.24	1.35	V
IN1 / IN2 / IN3 / IN4 Input Terminal ($T_J = 25^\circ C$)						
Input Voltage "H"	V_{IH}	-	$0.8*V_{DD}$	-	$V_{DD}+0.4$	V
Input Voltage "L"	V_{IL}	-	-0.4	-	$0.2*V_{DD}$	V
Input Current "H"	I_{IH}	$V_{IN} = V_{DD}$	-	-	± 5	μA
Input Current "L"	I_{IL}	$V_{IN} = 0 V$	-	-	± 5	μA
O1 / O2 / O3 / O4 Output Terminal ($T_J = 25^\circ C$)						
Output Voltage (upper + lower)	V_{OUT1}	$I_{OUT} = 200 mA$	-	0.2	0.35	V
	V_{OUT2}	$I_{OUT} = 400 mA$	-	0.4	0.75	V
	V_{OUT3}	$I_{OUT} = 400 mA$ (parallel connection)	-	0.2	0.45	V
	V_{OUT4}	$I_{OUT} = 800 mA$ (parallel connection)	-	0.5	0.8	V
Output Sustaining Voltage	$V_{O(SUS)}$	$I_{OUT} = 400 mA$	-	-	V_S	V

Truth Table

IN1 / IN3	IN2 / IN4	O1 / O3	O2 / O4	Mode
H	L	H	L	Forward
L	H	L	H	Reverse
H	H	H	H	Brake
L	L	OFF	OFF	Standby

Block Diagram & Application Circuit

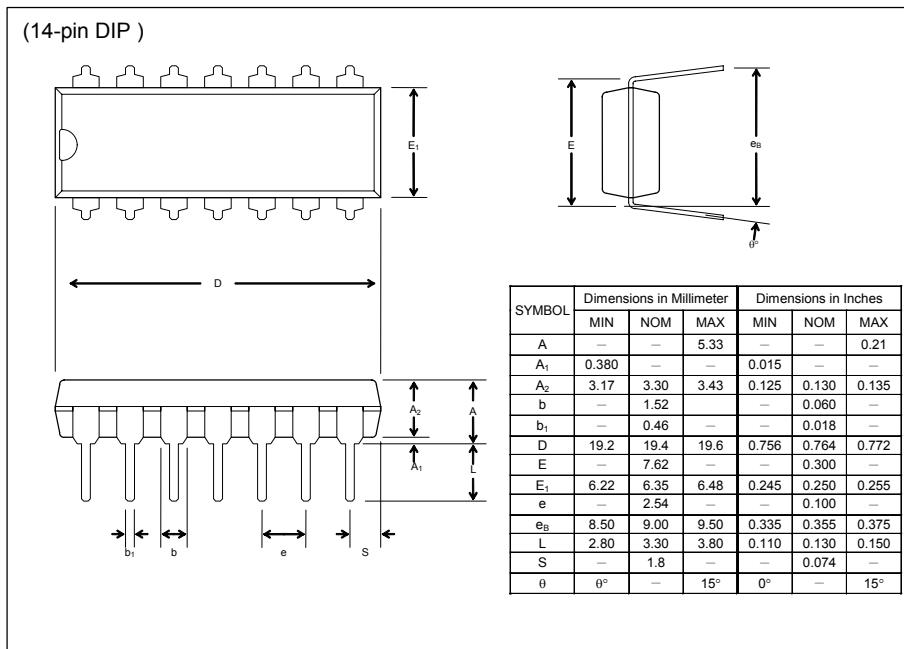
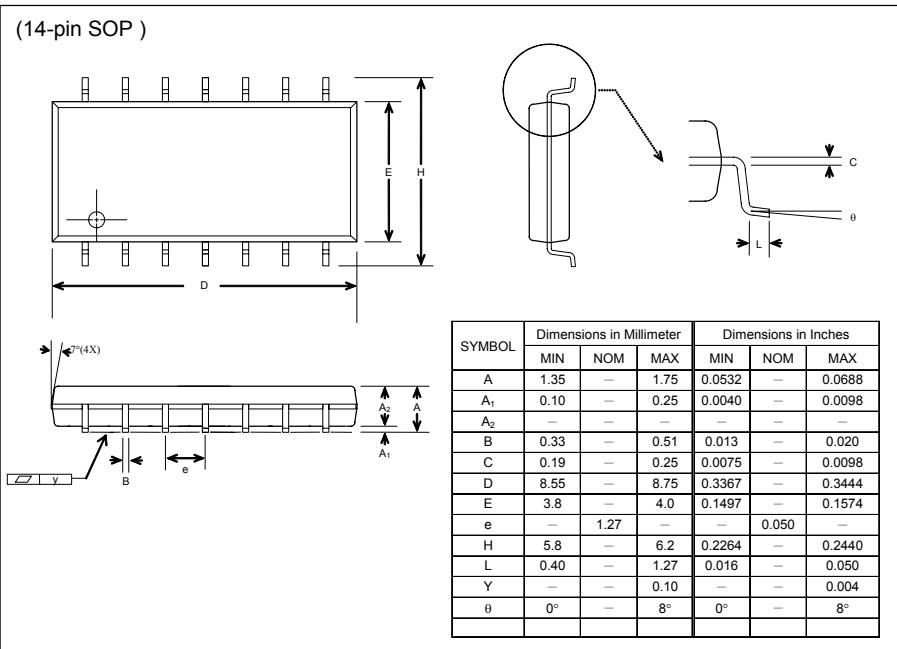


Application Notes

- In multiple power supply application, to get suitable input voltage range from external controller, it is suggestion connecting VDD pin to the same power source with external controller.
- To increase system stability, it is suggestion to connect a resistor R_{VDD} about 100Ω between battery power and driver's VDD pin as shown on application circuit.
- The VR pin is a voltage reference output in DIP14 package, let VR pin in floating state in the application.
- The power dissipated by the IC varies widely with the supply voltage, the output current, and loading. It is important to ensure the application does not exceed the allowable power dissipation of the IC package.



Package Specifications





The products listed herein are designed for ordinary electronic applications, such as electrical appliances, audio-visual equipment, communications devices and so on. Hence, it is advisable that the devices should not be used in medical instruments, surgical implants, aerospace machinery, nuclear power control systems, disaster/crime-prevention equipment and the like. Misusing those products may directly or indirectly endanger human life, or cause injury and property loss.

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